

SMD Comm COG HV Flex, Ceramic, 3300 pF, 5%, 500 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1210



General Information	
Series:	SMD Comm COG HV Flex
Style:	SMD Chip
Description:	SMD, MLCC, FT-CAP, Ultra-Stable
Features:	FT-CAP, Ultra-Stable
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Shelf Life:	78 Weeks
MSL:	1

Dimensions	
Chip Size	1210
L	3.3mm +/-0.4mm
W	2.6mm +/-0.3mm
T	2.5mm +/-0.30mm
B	0.6mm +/-0.25mm

Packaging Specifications	
Packaging:	T&R, 330mm, Plastic Tape
Packaging Quantity:	4000

Specifications	
Capacitance:	3300 pF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	5%
Voltage DC:	500 VDC
Dielectric Withstanding Voltage:	750 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor:	0.1% 1 kHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	100 GOhms